

ABSOLUTE MAXIMUM RATINGS¹ ($T_A = 25^\circ\text{C}$)

SYMBOLS	PARAMETERS	UNITS	RATINGS
V _{CC}	Power Supply Voltage	V	-0.5 to 6.0
P _{IN}	Input Power	dBm	+10
P _T	Total Power Dissipation ²	mW	330
T _{OP}	Operating Temperature	°C	-45 to +85
T _{STG}	Storage Temperature	°C	-55 to +150

Notes:

- Operation in excess of any one of these parameters may result in permanent damage.
- Mounted on 50 x 50 x 1.6 mm glass epoxy PWB at $T_A = +85^\circ\text{C}$.

RECOMMENDED OPERATING CONDITIONS

SYMBOLS	CHARACTERISTICS	UNITS	MIN	TYP	MAX
V _{CC}	Supply Voltage	V	4.5	5.0	5.5
T _{OP}	Operating Temperature	°C	-40	+25	+85

PIN DESCRIPTIONS

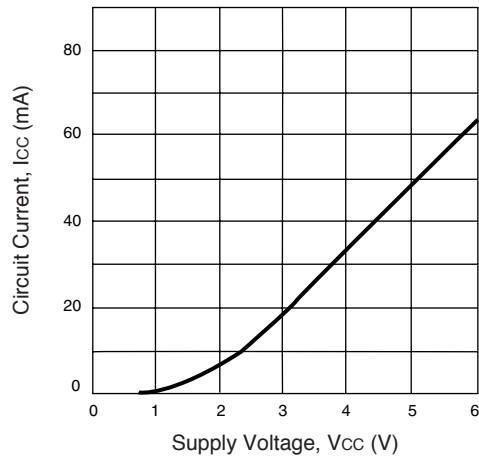
Pin No.	Pin Name	Applied Voltage (V)	Description	Internal Equivalent Circuit
1	Input	—	Signal input pin. An internal matching circuit, configured with resistors, enables a 50 Ω connection over a wide band. A multi-feedback circuit is designed to cancel the deviations of h_{FE} and resistance. This pin must be coupled to the signal source with a blocking capacitor.	
5	Output	Voltage same as V _{CC} through external inductor	Signal output pin. This output is designed as an open collector for Darlington transistors. Connect an inductor between this pin and V _{CC} pin to supply current to the internal output transistors. The inductor should be selected for high frequency use and small DC resistance.	
8	V _{CC}	4.5 to 5.5	Power supply pin. This pin should be externally equipped with a bypass capacitor to minimize ground impedance.	
6 7	GND	0	Ground pins of internal input stage. Form a ground pattern as wide as possible to minimize ground impedance.	
2 3 4	GND	0	Ground pins of internal output stage. All the ground pins including pins 6 and 7 must be connected together with a wide ground pattern to decrease impedance difference.	

Note:

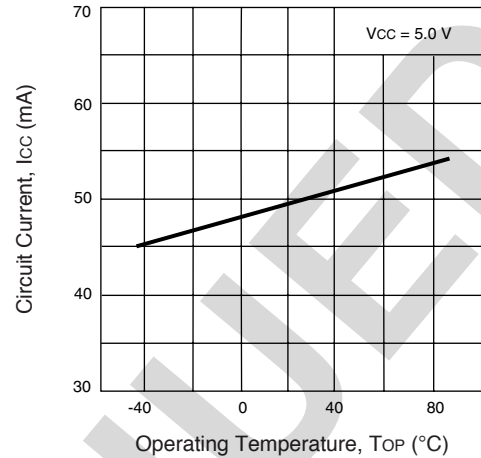
Pin Voltage for Pin 1 is 1.17, measured at V_{CC} = V_{OUT} = 5.0 V.

TYPICAL PERFORMANCE CURVES ($T_A = 25^\circ\text{C}$)

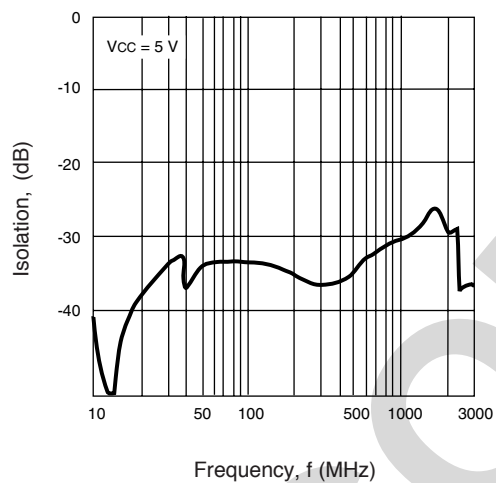
CIRCUIT CURRENT vs. SUPPLY VOLTAGE



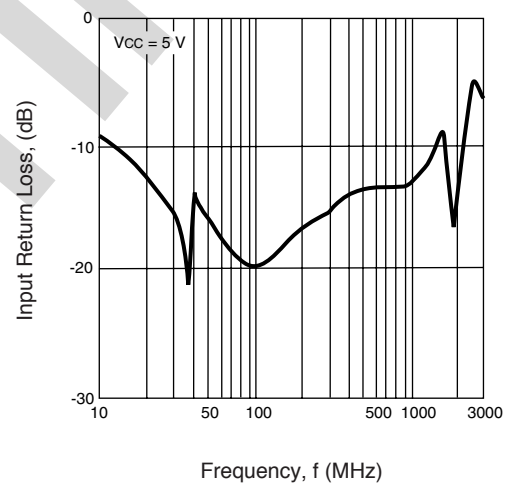
CIRCUIT CURRENT vs. OPERATING TEMPERATURE



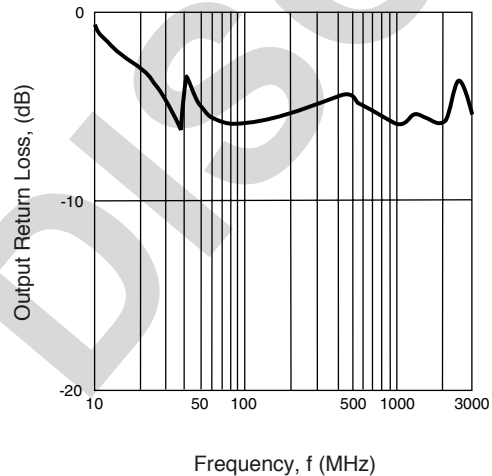
ISOLATION vs. FREQUENCY



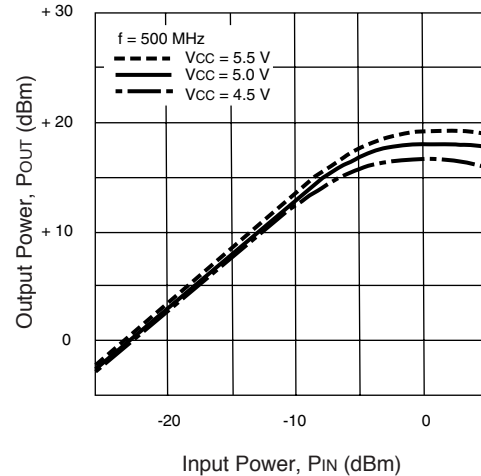
INPUT RETURN LOSS vs. FREQUENCY

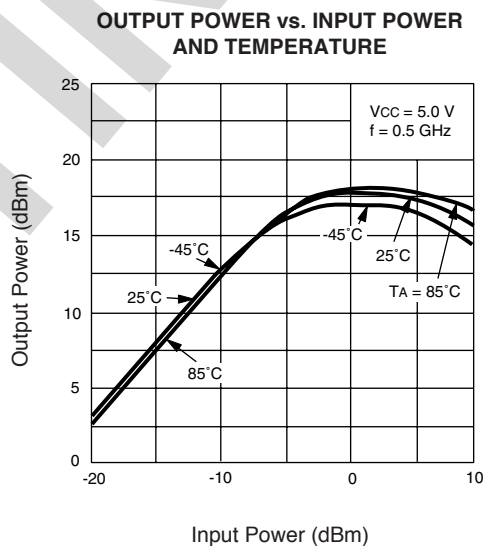
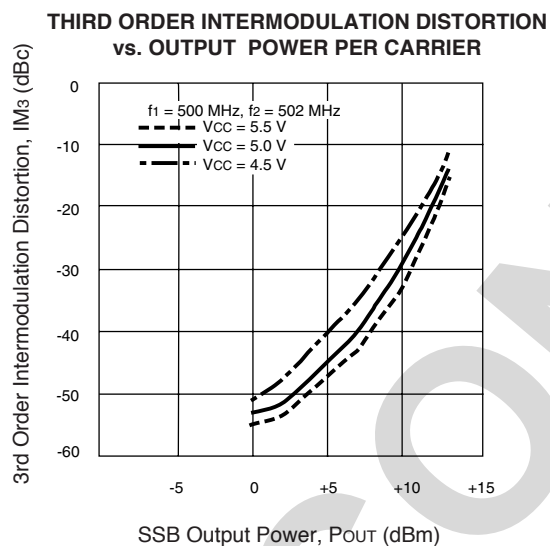
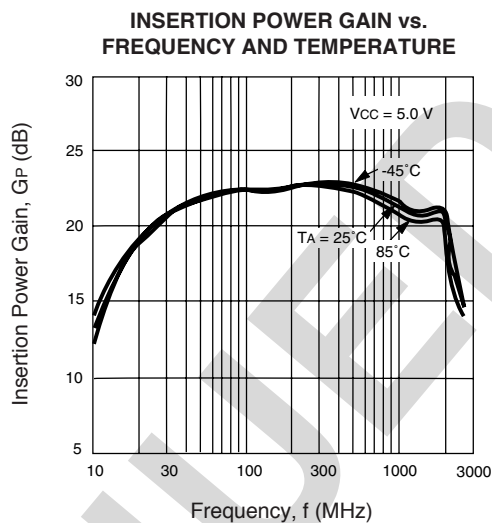
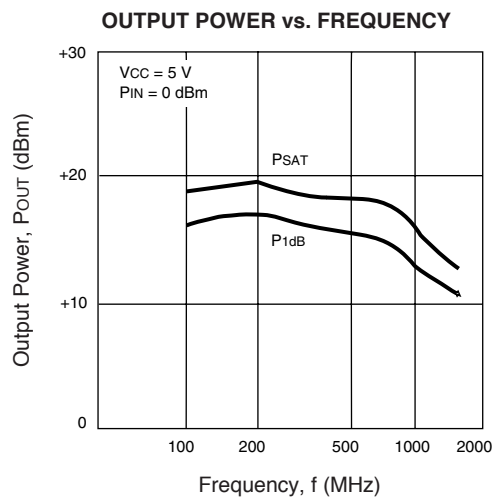


OUTPUT RETURN LOSS vs. FREQUENCY

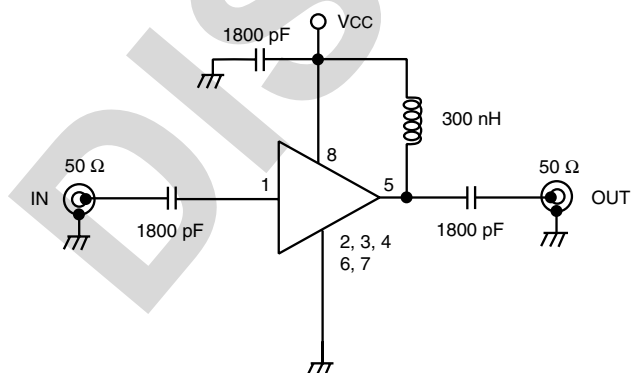


OUTPUT POWER vs. INPUT POWER



TYPICAL PERFORMANCE CURVES ($T_A = 25^\circ\text{C}$)

TEST CIRCUIT



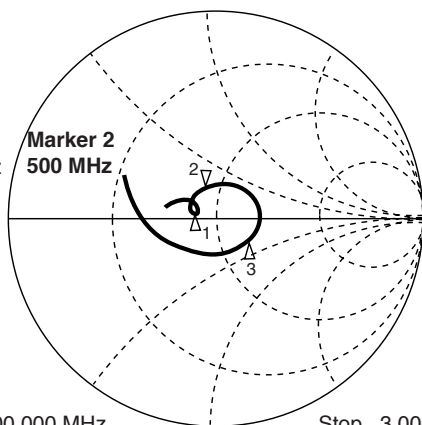
Precautions: 1) These devices are ESD sensitive. Use proper precautionary measures when handling and installing these devices.

TYPICAL SCATTERING PARAMETERS ($V_{CC} = 5.0\text{ V}$, $T_A = 25^\circ\text{C}$)**S11 Frequency**

1: 40.846 Ω
1.9785 Ω
100 MHz

2: 43.174 Ω
12.344 Ω
500 MHz

3: 66.441 Ω
-14.414 Ω
1.7 GHz



Start 10.000 000 MHz

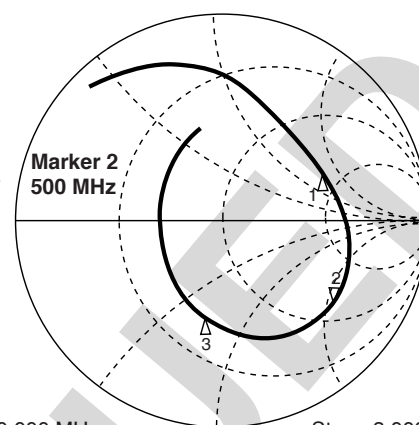
Stop 3,000.000 MHz

S22 Frequency

1: 121.86 Ω
71.563 Ω
100 MHz

2: 77.645 Ω
-111.17 Ω
500 MHz

3: 26.904 Ω
-34.393 Ω
1.7 GHz



Start 10.000 000 MHz

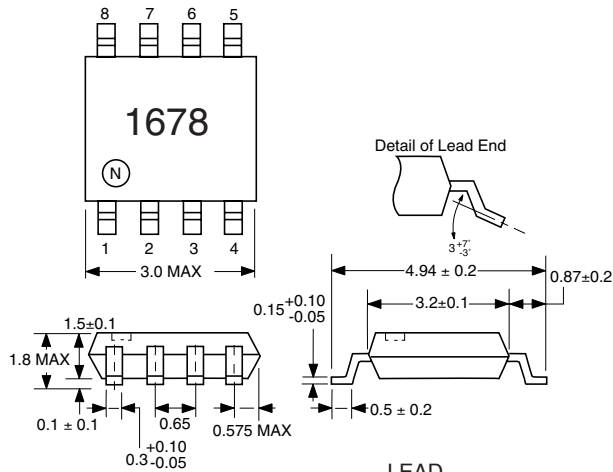
Stop 3,000.000 MHz

UPC1678GV **$V_{CC} = 5\text{ V}$, $I_{CC} = 50\text{ mA}$**

FREQUENCY	S11		S21		S12		S22		K	S21
(GHz)	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG		(dB)
0.05	0.136	157	10.2	36	0.018	3	0.683	89	1.59	23.0
0.10	0.106	164	12.1	18	0.025	26	0.609	53	1.25	23.8
0.20	0.126	165	13.2	3	0.020	15	0.621	22	1.34	24.6
0.40	0.174	144	14.4	-17	0.017	50	0.673	-10	1.24	26.4
0.60	0.184	119	15.0	-35	0.024	71	0.657	-37	0.85	27.9
0.80	0.150	107	14.6	-52	0.033	75	0.619	-64	0.78	26.5
1.00	0.102	115	15.1	-70	0.038	77	0.599	-89	0.78	26.0
1.20	0.112	148	14.0	-88	0.040	83	0.585	-116	0.81	25.4
1.40	0.169	151	12.4	-114	0.046	92	0.542	-142	0.81	24.4
1.60	0.180	137	11.3	-131	0.054	99	0.449	-163	0.86	23.2
1.80	0.146	121	7.6	-144	0.063	101	0.335	-177	1.10	18.8
2.00	0.072	89	6.2	-159	0.073	102	0.224	-177	1.25	16.2
2.20	0.045	-37	4.6	-157	0.081	100	0.192	-163	1.49	13.4
2.40	0.137	-84	3.9	-164	0.085	97	0.206	-157	1.60	12.1
2.50	0.180	-95	3.9	-161	0.088	95	0.219	-158	1.54	12.2

OUTLINE DIMENSIONS (Units in mm)

**UPC1678GV
PACKAGE OUTLINE S08**



- LEAD
CONNECTIONS**
- | | |
|----------|-----------|
| 1. Input | 5. Output |
| 2. GND | 6. GND |
| 3. GND | 7. GND |
| 4. GND | 8. Vcc |

ORDERING INFORMATION (Solder Contains Lead)

PART NUMBER	QTY
UPC1678GV-E1	1000/REEL

Note: Embossed tape, 8 mm wide. Pin 1 is in tape pull-out direction.

ORDERING INFORMATION (Pb-Free)

PART NUMBER	QTY
UPC1678GV-E1-A	1000/REEL

Note: Embossed tape, 8 mm wide. Pin 1 is in tape pull-out direction.

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

CEL California Eastern Laboratories, Your source for NEC RF, Microwave, Optoelectronic, and Fiber Optic Semiconductor Devices.

4590 Patrick Henry Drive • Santa Clara, CA 95054-1817 • (408) 919-2500 • FAX (408) 988-0279 • www.cel.com

DATA SUBJECT TO CHANGE WITHOUT NOTICE

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
		-A	-AZ
Lead (Pb)	< 1000 PPM	Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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